

HSF Compliant

REV.	ECN NO.	DESCRIPTION	DRAW	CHECK	APPD.	DATE
X0	—	新版发行	YIN	BENDEE	BENDEE	2021.08.05

MATERIALS

- 1.HOUSING:LCP, (UL 94V-0), BLACK
- 2.TERMINAL:BRASS (C2680),
GOLD PLATING 15u" Min. ON CONTACT AREA,
MATTE TIN 80u" Min. PLATING ON SOLDER TAIL,
UNDER NICKEL PLATING 50u" Min OVER ALL.
- 3.SHELL:Stainless Steel, NICKEL PLATING 30u" Min.
- 4.CAP:LCP, (UL 94V-0), BLACK

SPECIFICATION

- 1.CURRENT RATING : 0.5 A MAX.
- 2.DIELECTRIC WITHSTANDING VOLTAGE : 500V AC R.M.S.
FOR ONE MINUTE.
- 3.INSULATION RESISTANCE : 100M OHMS MIN.
4. CONTACT RESISTANCE : 30m OHMS MAX.
5. OPERATING TEMPERATURE : -20°C TO +85°C.
6. INSERTION FORCE : 4.5kgf MAX.
7. EXTRACTION FORCE : 1.0~4.0kgf MIN.
8. SALT SPRAY : 48 HOURS PASS.
9. REFLOW SOLDERING(SMD COMPONENT) OVEN
- 10.TEMPERATURE:260°C.5SEC

料号备注

R=PACK-TXXXX

CP 0 F 019 M XX X XX X X

12=半金雾锡10"
13=半金雾锡30"
14=半金雾锡50"
15=半金雾锡15U"
16=半金雾锡30U"

00=LCP黑不锈钢壳镀镍

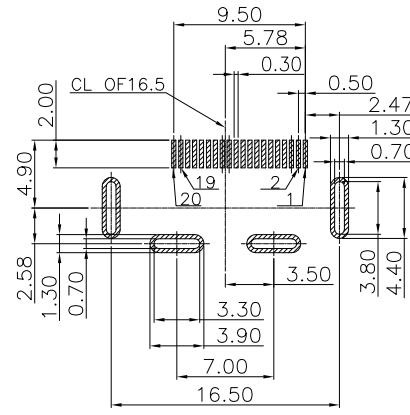
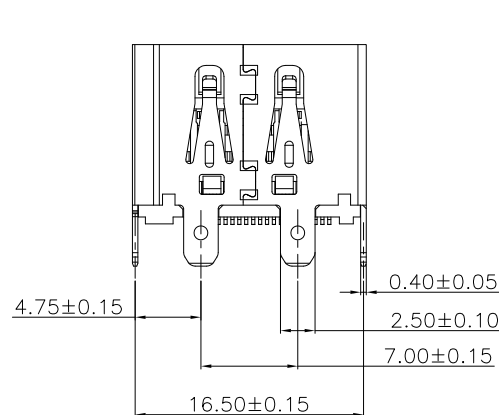
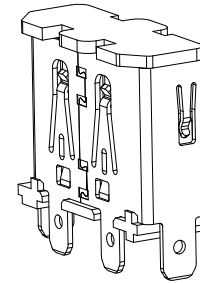
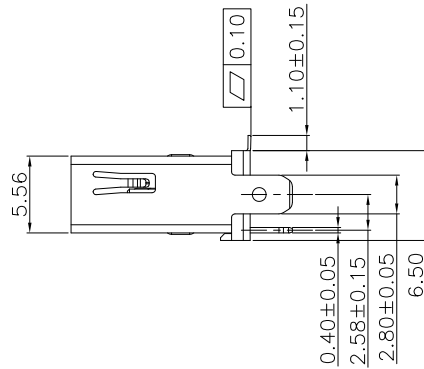
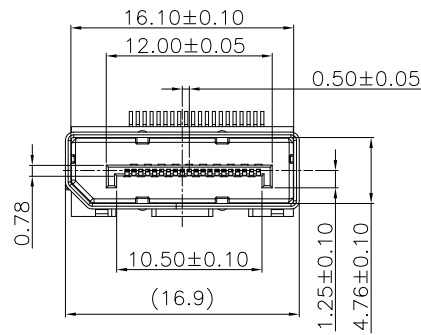
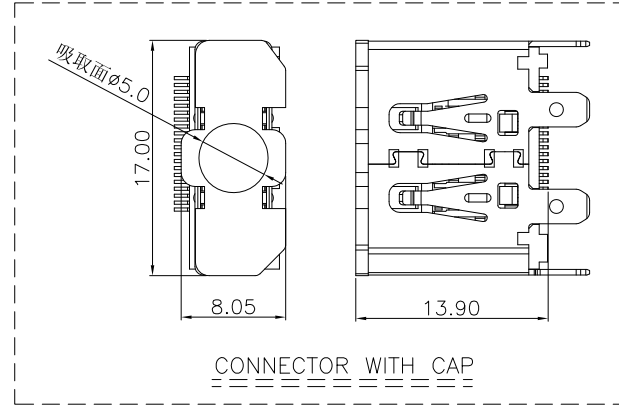
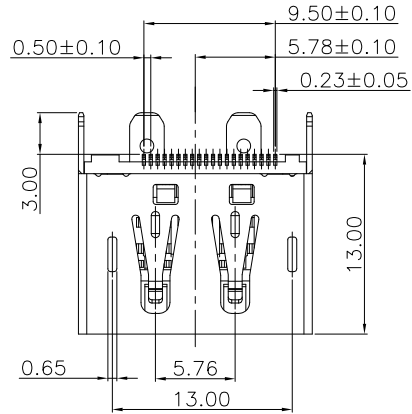
R=ROHS2.0标准
W=无卤+ROHS2.0
H=REACH标准

B=盐雾24H
C=盐雾48H



东莞市兴科杰鑫电子有限公司
Dong Guan XingKeJieXin Electronics Co.,Ltd

UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL	日期	品名规格	DISPLAY PORT SMT直立式H13.0mm(无弹)	
.X	+/-	制图	YIN	2021.08.05	规格	
.XX	+/-	审核			料号	SEE TABLE
.XXX	+/-	核准			文件位置	
FRACTIONS	+/-	ANGLE OF PROJECTION		字张	工程图号:	版本.
ANGLES	+/-	2.00°		A4	DWG-CPAF-019	X0
DIMENSIONS				比例	1 : 1	状态码 A
(METRIC)	(MM)			页数	1	OF 1



RECOMMENDED P.C.B LAYOUT(TOP VIEW)
TOLERANCE: ±0.05